



Product data sheet

1. General description

Ultrafast power diode in a SOD59 (2-lead TO-220AC) plastic package.

2. Features and benefits

- Fast switching
- Guaranteed ESD capability
- High thermal cycling performance
- Low on-state loss
- Low thermal resistance
- Rugged: reverse voltage surge capability
- Soft recovery minimizes power-consuming oscillations

3. Applications

• Output rectifiers in high-frequency switched-mode power supplies

4. Quick reference data

Symbol	Parameter	Conditions	Values			Unit	
Absolute	maximum rating						
V_{RRM}	repetitive peak reverse voltage			1	50		V
$I_{F(AV)}$	average forward current	δ = 0.5 ; T _{mb} ≤ 128 °C; square-wave pulse; Fig. 1; Fig. 2	8		A		
I _{FRM}	repetitive peak forward current	δ = 0.5 ; t _p = 25 μs; T _{mb} ≤ 128 °C; square-wave pulse	16			A	
I _{FSM}	non-repetitive peak	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	80			А	
	forward current	t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	88			А	
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static ch	aracteristics						
V _F	forward voltage	I _F = 8 A; T _j = 25 °C; <u>Fig. 4</u>		-	0.92	1.05	V
Dynamic	characteristics					-	
t _{rr}	reverse recovery time	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 100 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; \text{ ramp recovery}; Fig. 5; Fig. 7$		-	20	25	ns
Electros	atic discharge						
V_{ESD}	electrostatic discharge voltage	HBM; C = 250 pF; R = 1.5 kΩ		-	-	8	kV

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	К	cathode	mb	
2	A	anode	j j O j	К — Ң — А
mb	mb	mounting base; cathode	C () () () () () () () () () ()	001aaa020

6. Ordering information

Table 3. Ordering information						
Type number	Package	skage				
	Name	Description	Version			
BYW29E-150	TO-220AC	plastic single-ended package; heatsink mounted; 1 mounting hole; 2-lead TO-220AC	SOD59			

7. Marking

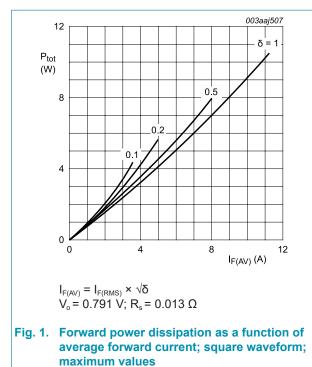
Table 4. Marking codes					
Type number	Marking codes				
BYW29E-150	BYW29E-150				

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V_{RRM}	repetitive peak reverse voltage		150	V
V _{RWM}	crest working reverse voltage		150	V
V _R	reverse voltage		150	V
I _{F(AV)}	average forward current	δ = 0.5 ; T _{mb} ≤ 128 °C ;square-wave pulse; Fig. 1; Fig. 2	8	A
I _{FRM}	repetitive peak forward current	δ = 0.5 ; t _p = 25 μs; T _{mb} ≤ 128 °C; square-wave pulse	16	A
I _{FSM}	non-repetitive peak	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	80	А
	forward current	t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	88	А
I _{RRM}	repetitive peak reverse current	δ = 0.001; t _p = 2 μs	0.2	A
I _{RSM}	non-repetitive peak reverse current	t _p = 100 μs	0.2	A
T _{stg}	storage temperature		-40 to 150	°C
T _j	junction temperature		150	°C
Electrosta	atic discharge	·		
V_{ESD}	electrostatic discharge voltage	HBM; C = 250 pF; R = 1.5 kΩ	8	kV



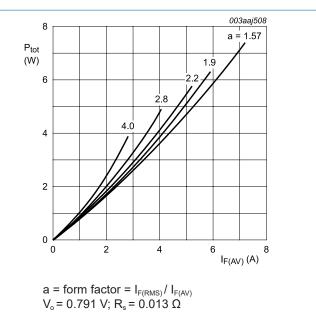
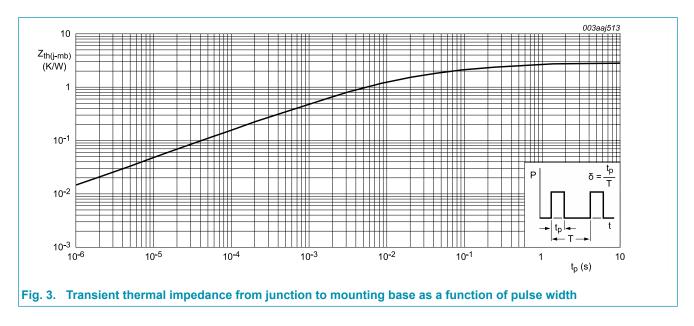


Fig. 2. Forward power dissipation as a function of average forward current; sinusoidal waveform; maximum values

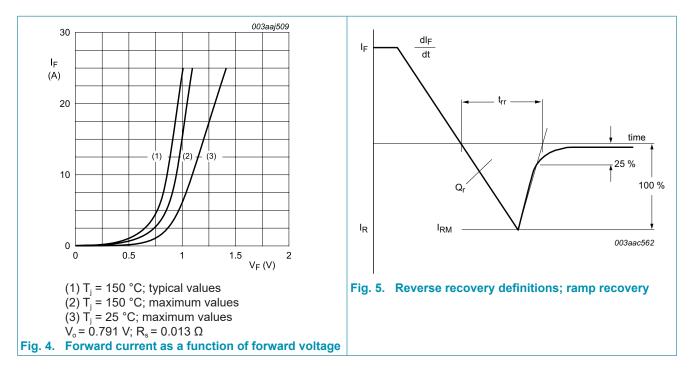
9. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	<u>Fig. 3</u>	-	-	2.7	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient	in free air	-	60	-	K/W

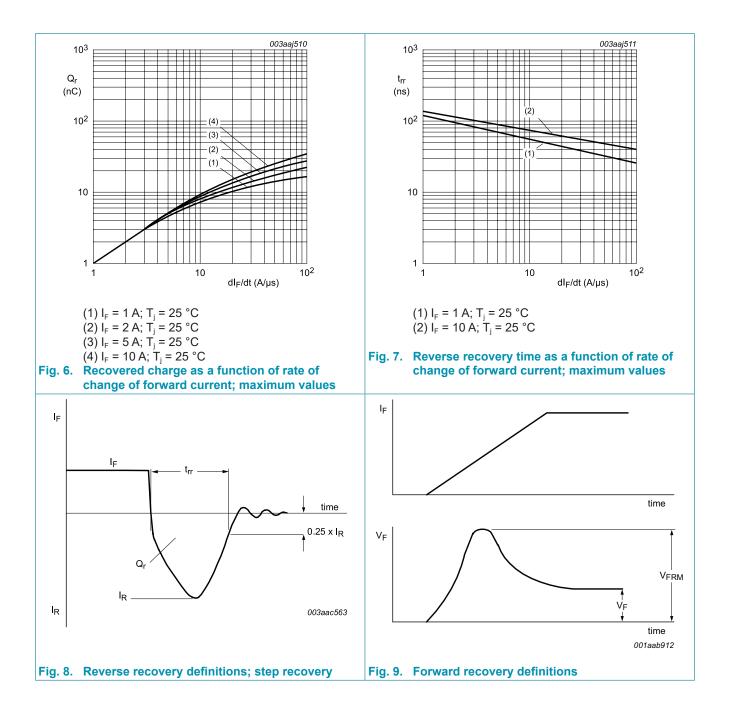


10. Characteristics

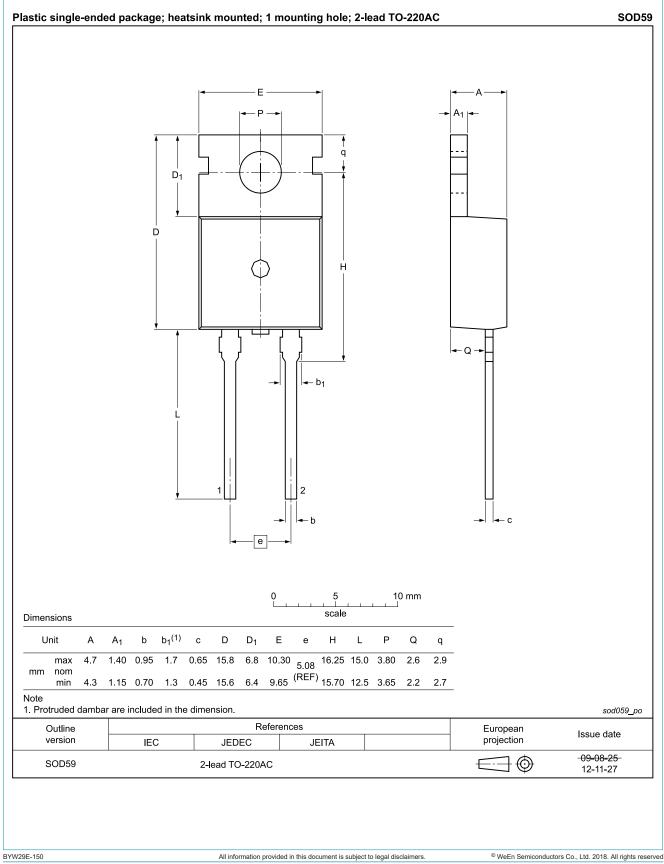
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static cha	racteristics						
$V_{\rm F}$	forward voltage	I _F = 8 A; T _j = 25 °C; <u>Fig. 4</u>		-	0.92	1.05	V
		I _F = 20 A; T _j = 25 °C; <u>Fig. 4</u>		-	1.1	1.3	V
		I _F = 8 A; T _j = 150 °C; <u>Fig. 4</u>		-	0.8	0.895	V
Ι _R	reverse current	V _R = 150 V; T _j = 25 °C		-	2	10	μA
		V _R = 150 V; T _j = 100 °C		-	0.2	0.6	mA
Dynamic	characteristics		·		_		
Q _r	recovered charge	$I_{F} = 2 \text{ A}; V_{R} = 30 \text{ V}; \text{ d}_{F}/\text{d}t = 20 \text{ A}/\mu\text{s}; T_{j} = 25 \text{ °C}; Fig. 5; Fig. 6$		-	4	11	nC
t _{rr}	reverse recovery time	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; \text{ d}I_F/\text{d}t = 100 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; \text{ ramp recovery}; \underline{\text{Fig. 5}; \underline{\text{Fig. 7}}}$		-	20	25	ns
		$I_{F} = 0.5 \text{ A}; I_{R} = 1 \text{ A}; I_{R(meas)} = 0.25 \text{ A};$ $T_{j} = 25 \text{ °C}; \text{ step recovery; } Fig. 8$		-	15	20	ns
V _{FRM}	forward recovery voltage	I _F = 1 A; dI _F /dt = 10 A/μs; T _j = 25 °C; <u>Fig. 9</u>		-	1	-	V



BYW29E-150 Ultrafast power diode



11. Package outline



12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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BYW29E-150 Ultrafast power diode

13. Contents

1. Gener	ral description	1
2. Featu	res and benefits	1
3. Applic	cations	1
4. Quick	reference data	1
5. Pinnir	ng information	2
6. Order	ing information	2
7. Marki	ng	2
8. Limiti	ng values	3
9. Therm	nal characteristics	4
10. Char	racteristics	5
11. Pack	age outline	7
12. Lega	al information	8
13. Cont	tents	10

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